

MOSFET

Metal Oxide Semiconductor Field Effect Transistor

CoolMOS™ P6

600V CoolMOS™ P6 Power Transistor IPW60R070P6

Data Sheet

Rev. 2.0 Final



IPW60R070P6

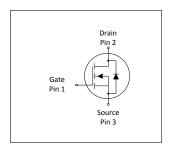
1 Description

CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. CoolMOS™ P6 series combines the experience of the leading SJ MOSFET supplier with high class innovation. The offered devices provide all benefits of a fast switching SJ MOSFET while not sacrificing ease of use. Extremely low switching and conduction losses make switching applications even more efficient, more compact, lighter and cooler.

TO-247

Features

- Increased MOSFET dv/dt ruggedness
- Extremely low losses due to very low FOM Rdson*Qg and Eoss
- Very high commutation ruggedness
- Easy to use/drive
- Pb-free plating, Halogen free mold compound
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)



Applications

PFC stages, hard switching PWM stages and resonant switching stages for e.g. PC Silverbox, Adapter, LCD & PDP TV, Lighting, Server, Telecom and UPS.





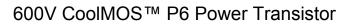
Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Table 1 Key Performance Parameters

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Parameter	Value	Unit						
V _{DS} @ T _{j,max}	650	V						
R _{DS(on),max}	70	mΩ						
Q _{g.typ}	100	nC						
I _{D,pulse}	156	А						
E _{oss} @400V	12.3	μJ						
Body diode di/dt	300	A/µs						

Type / Ordering Code	Package	Marking	Related Links
IPW60R070P6	PG-TO 247	6R070P6	see Appendix A





IPW60R070P6

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2 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatan	Or week al		Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current 1)	I _D	-	-	53.5 33.8	А	T _C =25°C T _C =100°C	
Pulsed drain current ²⁾	I _{D,pulse}	-	-	156	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	1136	mJ	I _D =9.3A; V _{DD} =50V; see table 10	
Avalanche energy, repetitive	E AR	-	-	1.72	mJ	I _D =9.3A; V _{DD} =50V; see table 10	
Avalanche current, repetitive	I _{AR}	-	-	9.3	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V _{DS} =0400V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation (Non FullPAK) TO-247	P _{tot}	-	-	391	W	T _C =25°C	
Storage temperature	T _{stg}	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque (Non FullPAK) TO-247	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	I _S	-	-	46.3	Α	T _C =25°C	
Diode pulse current ²⁾	I _{S,pulse}	-	-	156	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	15	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	300	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <= $I_{\rm S}$, $T_{\rm j}$ =25°C see table 8	

 $^{^{1)}}$ Limited by $T_{j\,max}.$ Maximum duty cycle D=0.75 $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical \textit{R}_{G}



3 Thermal characteristics

Table 3 Thermal characteristics (Non FullPAK) TO-247

Doromotor	Cumbal	Values		1111111	Nata / Tank Candidian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.32	°C/W	-
Thermal resistance, junction - ambient	R _{thJA}	-	-	62	°C/W	leaded
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s



4 Electrical characteristics at T_j =25°C, unless otherwise specified

Table 4 Static characteristics

Parameter	Oh a l		Values	;	Unit	
	Symbol	Min.	Тур.	Max.		Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_{D} =1mA
Gate threshold voltage	V _{(GS)th}	3.5	4.0	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.72{\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 10	5	μΑ	V _{DS} =600, V _{GS} =0V, T _j =25°C V _{DS} =600, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.063 0.164	0.070	Ω	V _{GS} =10V, I _D =20.6A, T _j =25°C V _{GS} =10V, I _D =20.6A, T _j =150°C
Gate resistance	R _G	-	1	-	Ω	f=1MHz, open drain

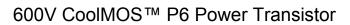
 Table 5
 Dynamic characteristics

Parameter	Ols al		Values			Nata / Tank Canadidan
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	4750	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz
Output capacitance	Coss	-	190	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz
Effective output capacitance, energy related 1)	C _{o(er)}	-	150	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	703	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V
Turn-on delay time	$t_{ m d(on)}$	-	23	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9
Rise time	t _r	-	15	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	64	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13 V, $I_{\rm D}$ =25.8A, $R_{\rm G}$ =1.7 Ω ; see table 9

Table 6 Gate charge characteristics

Parameter	Cumbal	Values			11:4	Nata / Tank Canadikian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	30	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	35	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V
Gate charge total	Q_g	-	100	-	nC	V_{DD} =400V, I_{D} =25.8A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	6.1	-	V	$V_{\rm DD}$ =400V, $I_{\rm D}$ =25.8A, $V_{\rm GS}$ =0 to 10V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V





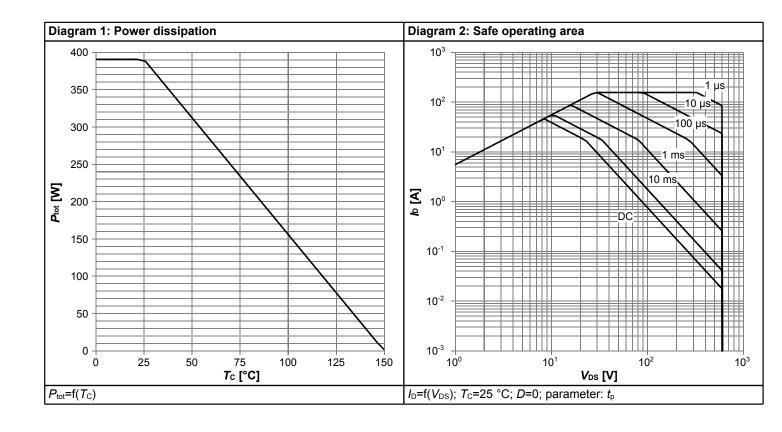
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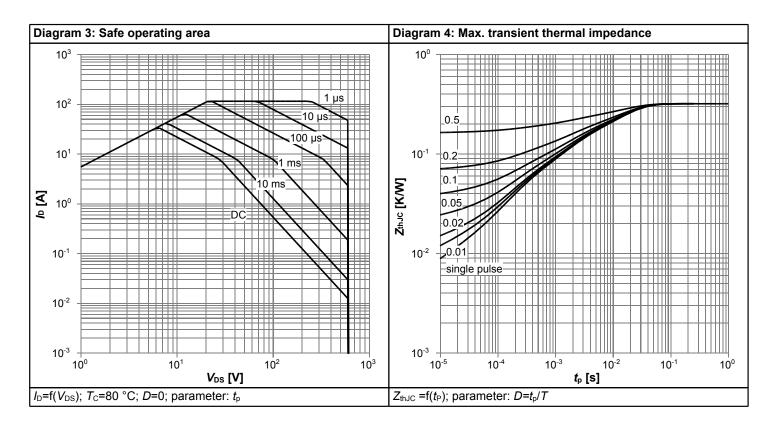
Table 7 Reverse diode characteristics

Parameter	Symbol	Values			11	Nata / Task Condition
		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.9	-	V	V _{GS} =0V, I _F =25.8A, T _j =25°C
Reverse recovery time	t _{rr}	-	520	-	ns	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	12	-	μC	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	44	_	Α	V_R =400V, I_F =25.8A, di_F/dt =100A/ μ s; see table 8

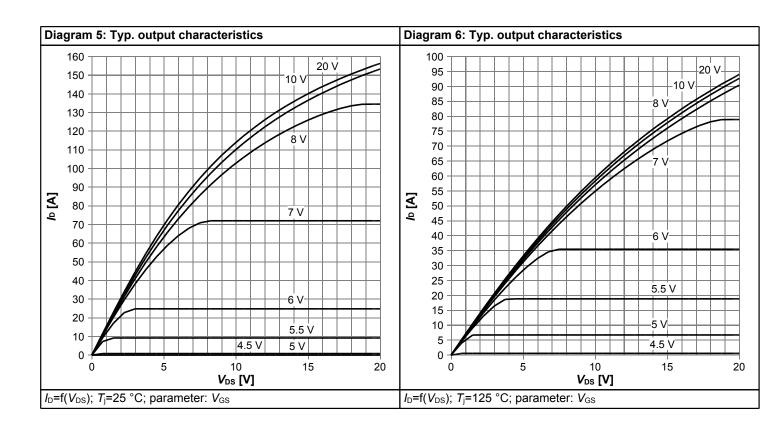


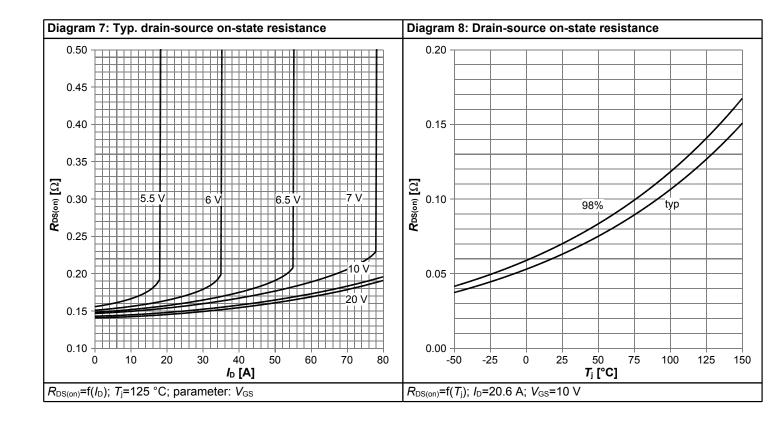
5 Electrical characteristics diagrams



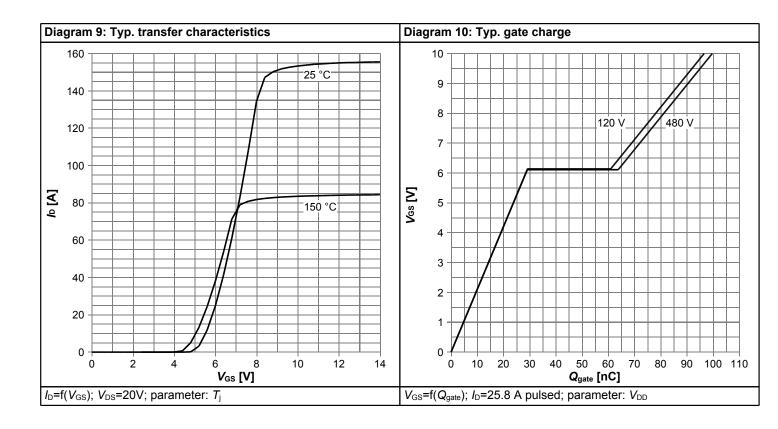


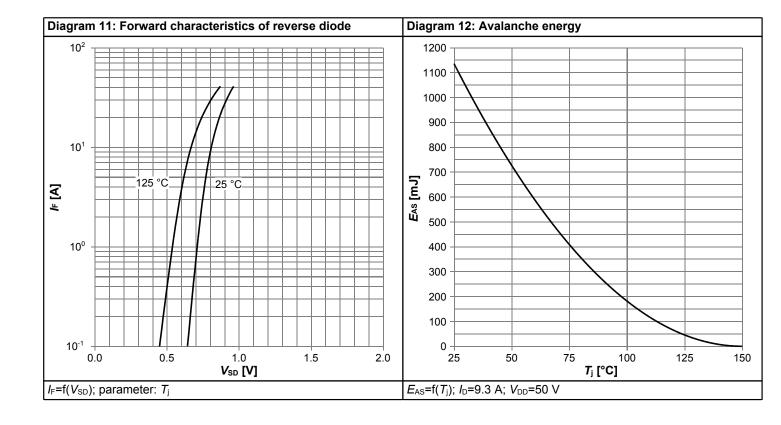




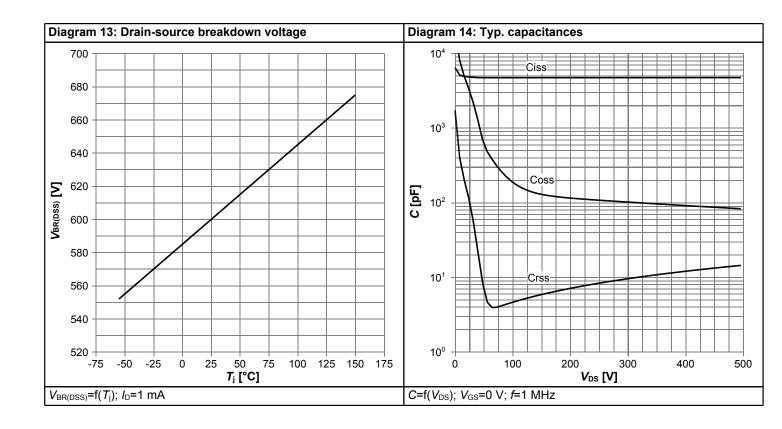


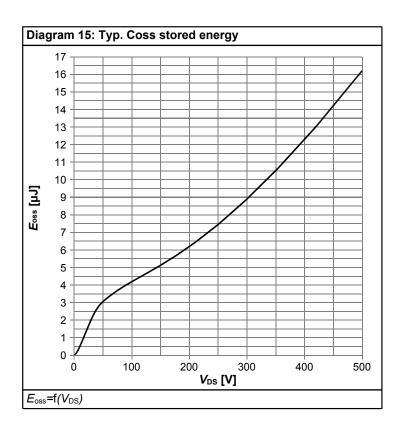














6 Test Circuits

Table 8 Diode characteristics

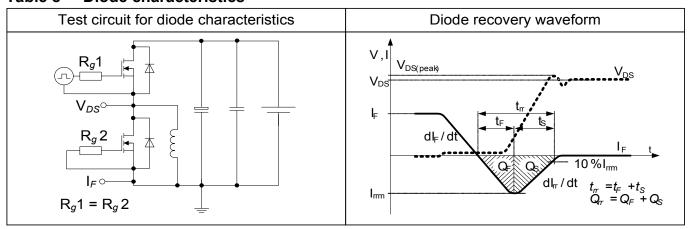


Table 9 Switching times

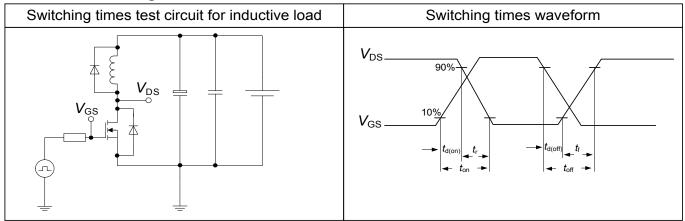
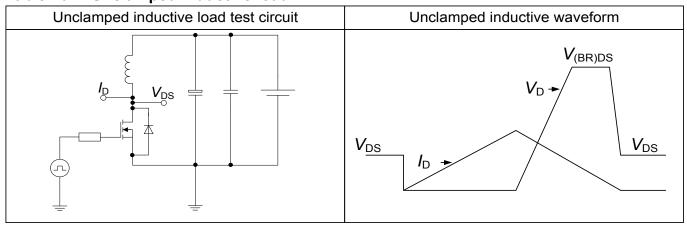


Table 10 Unclamped inductive load





7 Package Outlines

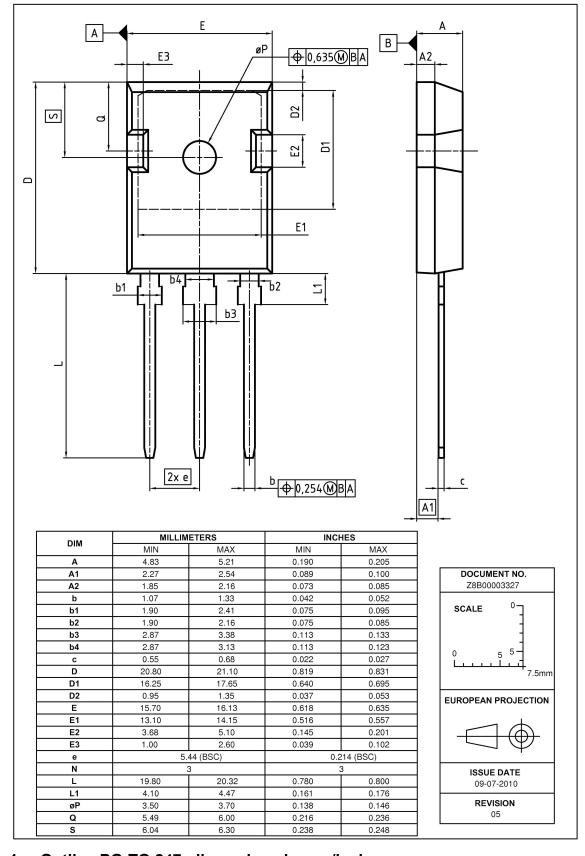


Figure 1 Outline PG-TO 247, dimensions in mm/inches



8 Appendix A

Table 11 Related Links

- IFX CoolMOS[™] P6 Webpage: www.infineon.com
- IFX CoolMOS[™] P6 application note: www.infineon.com
- IFX CoolMOS[™] P6 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com



600V CoolMOS™ P6 Power Transistor

IPW60R070P6

Revision History

IPW60R070P6

Revision: 2014-03-07, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2014-03-07	Release of final version

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